

PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In the Application of

Akira SAKAI et al.

Group Art Unit: 2829

Application No.: 10/807,235

Examiner: E. Pert

Filed: March 24, 2004

Docket No.: 119232

For: METHOD FOR FABRICATING A METALLIC OXIDE OF HIGH DIELECTRIC
CONSTANT, METALLIC OXIDE OF HIGH DIELECTRIC CONSTANT, GATE
INSULATING FILM AND SEMICONDUCTOR ELEMENT

SUBMISSION OF DECLARATION

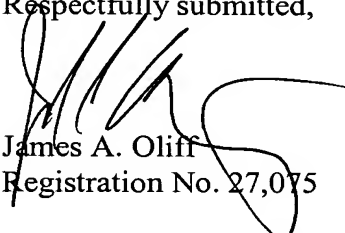
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Submitted herewith is a fully executed Declaration of the Inventors. Any necessary Designation of Ten Attorneys for Power of Attorney or Transmittal of Power of Attorney and Statement Under 37 C.F.R. §3.73(b) is also attached. Entry of this document should resolve any informalities.

The Commissioner is hereby authorized to charge any fees associated with this communication to deposit account number 15-0461.

Respectfully submitted,


James A. Oliff
Registration No. 27,075

Joel S. Armstrong
Registration No. 36,430

Leana Levin
Registration No. 51,939

JAO:JSA:LL/rav
Date: December 22, 2004

OLIFF & BERRIDGE, PLC
P.O. Box 19928
Alexandria, Virginia 22320
Telephone: (703) 836-6400

**DECLARATION AND POWER OF ATTORNEY
FOR APPLICATION FOR UNITED STATES PATENT**

As a below named inventor, I hereby declare that:
my residence, post office address and citizenship are as stated below under my name;

I verily believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

METHOD FOR FABRICATING A METALLIC OXIDE OF HIGH DIELECTRIC CONSTANT, METALLIC OXIDE OF HIGH DIELECTRIC CONSTANT, GATE INSULATING FILM AND SEMICONDUCTOR ELEMENT
described and claimed in the specification:

Check one

*a. ☐ attached hereto.

b. ☒ filed on March 24, 2004 as Application Serial No. 10/807,235.

I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose to the Office all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations §1.56. Under Title 35, U.S. Code §119, the priority benefits of the following foreign application(s) filed within one year prior to this application are hereby claimed:

Japanese Patent Application No. 2003-172,182 filed June 17, 2003

The following application(s) for patent or inventor's certificate on this invention were filed in countries foreign to the United States of America either (a) more than one year prior to this application, or (b) before the filing date of the above-named foreign priority application(s):

I hereby appoint the following as my attorneys of record with full power of substitution and revocation to prosecute this application and to transact all business in the Patent Office:

James A. Oliff, Reg. No. 27,075; William P. Berridge, Reg. No. 30,024;
Kirk M. Hudson, Reg. No. 27,562; Thomas J. Pardini, Reg. No. 30,411; and
Edward P. Walker, Reg. No. 31,450.

ALL CORRESPONDENCE IN CONNECTION WITH THIS APPLICATION SHOULD BE SENT TO OLIFF & BERRIDGE, P.O. BOX 19928, ALEXANDRIA, VIRGINIA 22320, TELEPHONE (703) 836-6400.

I hereby declare that I have reviewed and understand the contents of this Declaration, and that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

1	Typewritten Full Name of Sole or First Inventor	<u>Akira</u>	<u>SAKAI</u>
		Given Name	Family Name
2	Inventor's Signature	<u>A. Sakai</u>	
3	Date of Signature	<u>MAY 7, 2004</u>	
	Residence	<u>Nagoya City,</u>	<u>Aichi Pref.,</u>
		City	State or Province
	Citizenship	<u>Japanese</u>	<u>Japan</u>
		Country	
	Post Office Address (Insert complete mailing address, including country)	<u>3-252, Shinonokaze, Midori-ku, Nagoya City, Aichi Pref.,</u>	
		<u>Japan</u>	

*If Box a. is checked, this form may be executed only when attached to the specification (including claims) at the end thereof.

Note to Inventor: Please sign name on line 2 exactly as it appears in line 1 and insert the actual date of signing on line 3.

IF THERE IS MORE THAN ONE INVENTOR USE PAGE 2 AND PLACE AN "X" HERE ☐

BEST AVAILABLE COPY

(Discard this page in a sole inventor application)

1 Typewritten Full Name of Joint Inventor Yukio YASUDA
 Given Name Middle Initial Family Name
 2 Inventor's Signature *Y. Yasuda*
 3 Date of Signature April 30, 2004
 Residence Aichi-gun, Aichi Pref., Japan
 City State or Province Country
 Citizenship Japanese
 Post Office Address 103, Gogoike, Nagakute-cho, Aichi-Gun,
 (Insert complete mailing address, including country) Aichi Pref., Japan

1 Typewritten Full Name of Joint Inventor Shigeaki ZATMA
 Given Name Middle Initial Family Name
 2 Inventor's Signature *Shigeaki Zaita*
 3 Date of Signature April 27, 2004
 Residence Kasugai City, Aichi Pref., Japan
 City State or Province Country
 Citizenship Japanese
 Post Office Address 5-5-64, Takakuradai, Kasugai City, Aichi Pref., Japan
 (Insert complete mailing address, including country)

1 Typewritten Full Name of Joint Inventor Mitsuo SAKASHITA
 Given Name Middle Initial Family Name
 2 Inventor's Signature *Mitsuo Sakashita*
 3 Date of Signature April 27, 2004
 Residence Nagoya City, Aichi Pref., Japan
 City State or Province Country
 Citizenship Japanese
 Post Office Address 2-1205-6, Tokushige, Midori-ku, Nagoya City,
 (Insert complete mailing address, including country) Aichi Pref., Japan

1 Typewritten Full Name of Joint Inventor Hiroki KONDO
 Given Name Middle Initial Family Name
 2 Inventor's Signature *Hiroki Kondo*
 3 Date of Signature April 27, 2004
 Residence Nagoya City, Aichi Pref., Japan
 City State or Province Country
 Citizenship Japanese
 Post Office Address 1-604, Iguchi, Tenpaku-ku, Nagoya City, Aichi Pref.,
 (Insert complete mailing address, including country) Japan

1 Typewritten Full Name of Joint Inventor Shinsuke SAKASHITA
 Given Name Middle Initial Family Name
 2 Inventor's Signature *Shinsuke SAKASHITA*
 3 Date of Signature April 25, 2004
 Residence Nagoya City, Aichi Pref., Japan
 City State or Province Country
 Citizenship Japanese
 Post Office Address 4-217, Uedayama, Tenpaku-ku, Nagoya City, Aichi Pref.,
 (Insert complete mailing address, including country) Japan

Note to Inventor: Please sign name on line 2 exactly as it appears in line 1 and insert the actual date of signing on line 3.

This form may be executed only when attached to the first page of the Declaration and Power of Attorney of the application to which it pertains.